

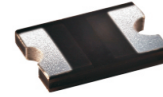
ACDBCT320-HF Thru. ACDBCT3100-HF

Forward current: 3.0A

Reverse voltage: 20 to 100V

RoHS Device

Halogen Free

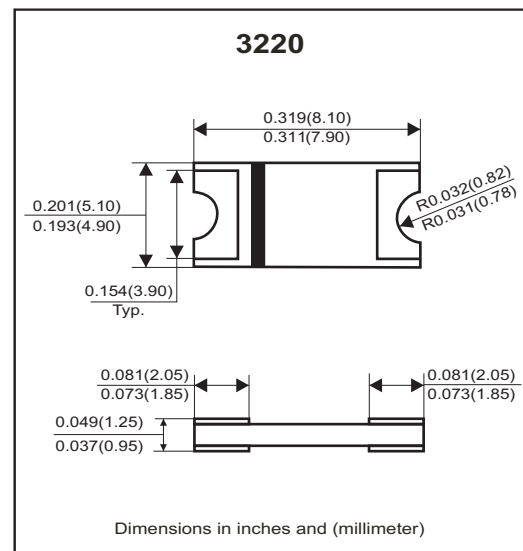


Features

- Lead less chip form, no lead damage.
- Low power loss, High efficiency.
- High current capability, low V_F
- Plastic package has UL 94V-0.
- Comply with AEC-Q101

Mechanical Data

- Case: Packed with FRP substrate and epoxy underfilled.
- Terminals: Pure Tin plated (Lead-Free), solderable per MIL-STD-750, method 2026.
- Polarity: Laser cathode band marking.
- Weight: 0.093 grams (approx).



Circuit diagram



Maximum Ratings (At $T_a=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	ACDBCT320-HF	ACDBCT340-HF	ACDBCT360-HF	ACDBCT3100-HF	Unit
Non-repetitive peak reverse voltage	V _{RM}	20	40	60	100	V
Average forward current	I _{F(AV)}	3				A
Peak forward surge current @8.3ms single half sine-wave	I _{FSM}	100				A
Operating junction temperature range	T _J	-55 to +125		-55 to +150		°C
Storage temperature	T _{STG}	-55 ~ +150				°C

Electrical Characteristics (At $T_a=25^\circ\text{C}$, unless otherwise noted)

Parameter	Conditions	Type	Symbol	Min.	Typ.	Max.	Unit
Forward voltage (Note1)	I _F =0.5A I _F =1.0A I _F =3.0A	ACDBCT320-HF / ACDBCT340-HF	V _F	-	0.33	-	V
				-	0.38	-	
				-	0.47	0.50	
	I _F =0.5A I _F =1.0A I _F =3.0A	ACDBCT360-HF		-	0.38	-	
				-	0.48	-	
				-	0.65	0.70	
	I _F =0.5A I _F =1.0A I _F =3.0A	ACDBCT3100-HF		-	0.48	-	
				-	0.58	-	
				-	0.78	0.85	
Reverse peak reverse current	V _R =Max.V _{RRM} , Ta=25°C		I _{RRM}	-	0.025	0.5	mA
Junction capacitance	V _R =4V, f=1.0MHz		C _j	-	180	-	pF
Thermal resistance	Junction to ambient (Note 2)		R _{θJA}	-	55	-	°C/W
	Junction to lead (Note 2)		R _{θJL}	-	17	-	°C/W

Notes: (1) Pulse test width $p_w=300\mu\text{sec}$, 1% duty cycle.

(2) Mounted on P.C. board with 0.2×0.2 (5.0*5.0mm) copper pad areas.

Company reserves the right to improve product design, functions and reliability without notice.

REV:B

RATING AND CHARACTERISTIC CURVES (ACDBCT320-HF Thru. ACDBCT3100-HF)

Fig.1 - Typical Forward Current Derating Curve

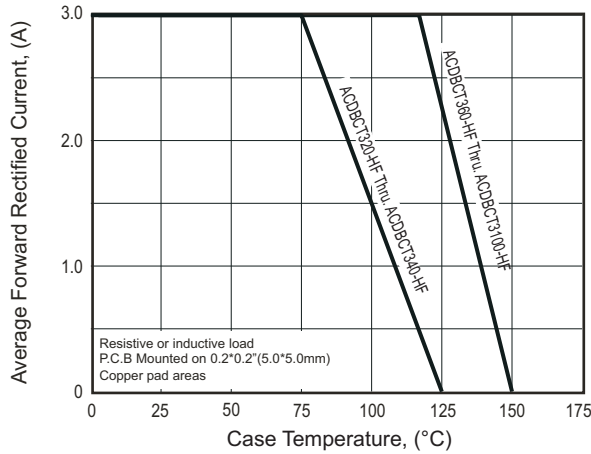


Fig.2 - Maximum Non-Repetitive Peak Forward Surge Current

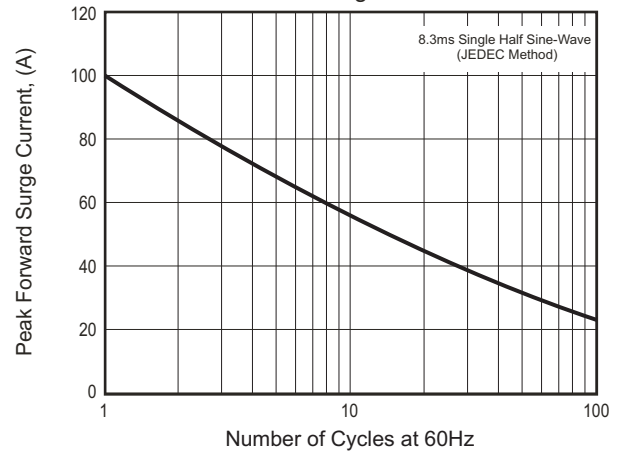


Fig.3 - Typical Instantaneous Forward Characteristics

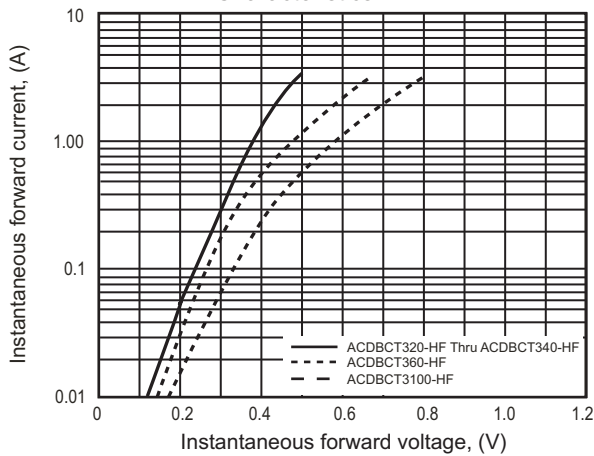


Fig.4 - Typical Reverse Characteristics

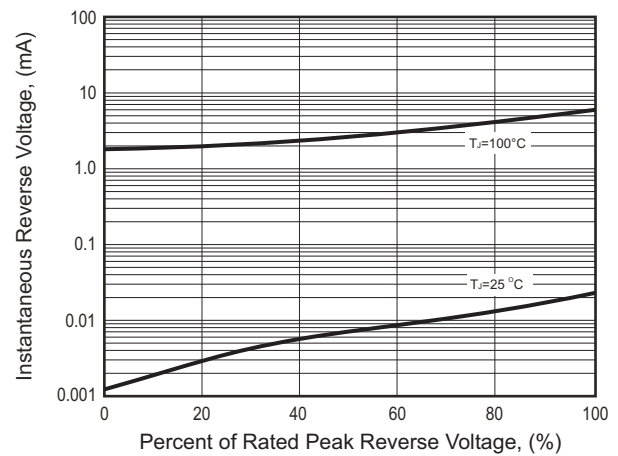
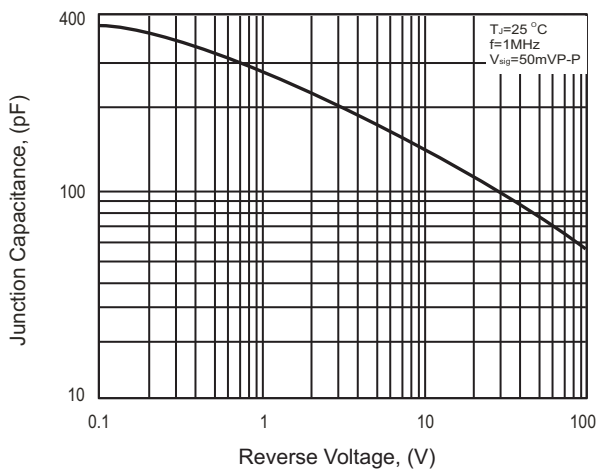
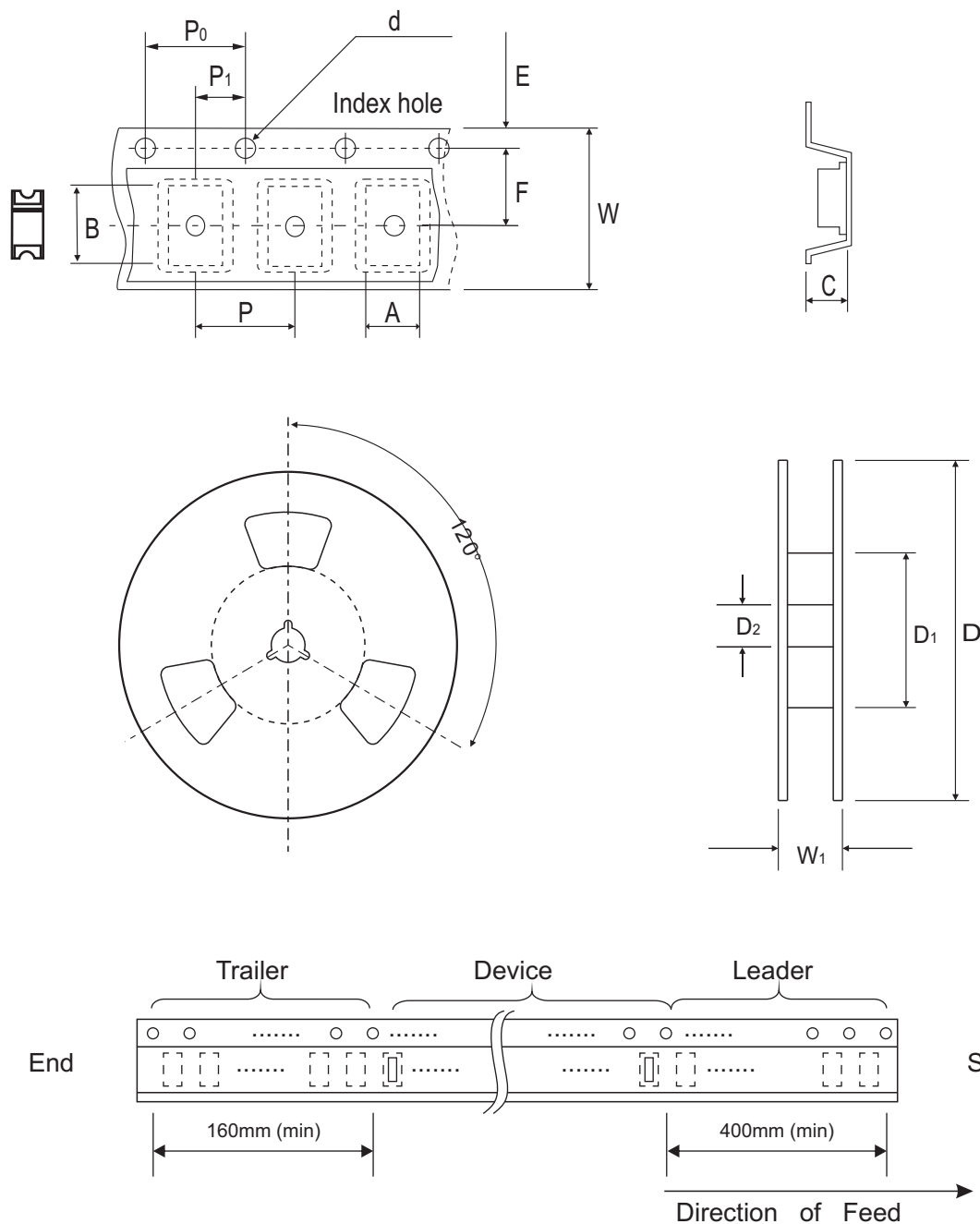


Fig.5 - Typical Junction Capacitance



Reel Taping Specification

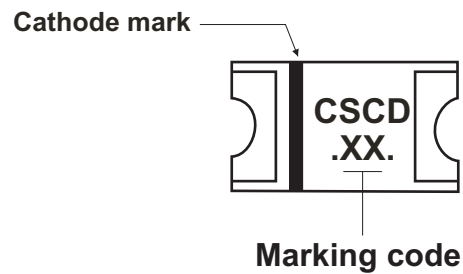


3220	SYMBOL	A	B	C	d	D	D ₁	D ₂
	(mm)	5.56 ± 0.10	8.18 ± 0.10	2.16 ± 0.10	1.55 ± 0.05	330 ± 2.00	50.0 MIN.	13.0 ± 0.50
	(inch)	0.219 ± 0.004	0.322 ± 0.004	0.085 ± 0.004	0.061 ± 0.002	12.992 ± 0.079	1.969 MIN.	0.512 ± 0.020

3220	SYMBOL	E	F	P	P ₀	P ₁	W	W ₁
	(mm)	1.75 ± 0.10	7.50 ± 0.10	8.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.10	16.00 ± 0.30	22.70 MAX.
	(inch)	0.069 ± 0.004	0.295 ± 0.004	0.315 ± 0.004	0.157 ± 0.004	0.079 ± 0.004	0.630 ± 0.012	0.893 MAX.

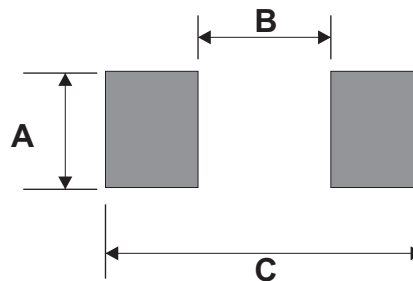
Marking Code

Part Number	Marking Code
ACDBCT320-HF	2
ACDBCT340-HF	4
ACDBCT360-HF	6
ACDBCT3100-HF	10



Suggested PAD Layout

SIZE	3220	
	(mm)	(inch)
A	3.90MIN.	0.154MIN.
B	4.10MAX.	0.161MAX.
C	11.90REF.	0.469 REF.



Standard Packaging

Case Type	REEL PACK	
	REEL (pcs)	Reel Size (inch)
3220	3,000	13

Mouser Electronics

Authorized Distributor

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